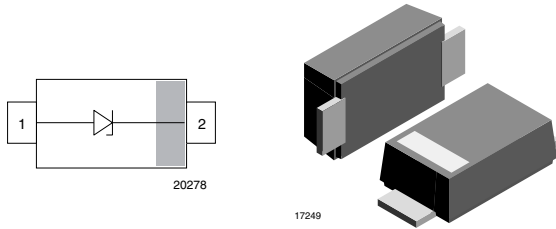
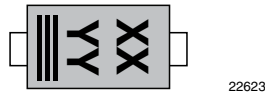


## Surface Mount ESD Protection Diodes



### MARKING (example only)



Bar = cathode marking  
 YY = type code (see table below)  
 XX = date code

### FEATURES

- For surface mounted applications
- Low-profile package
- Optimized for LAN protection applications
- Ideal for ESD protection of data lines in accordance with IEC 61000-4-2 (IEC 801-2)
- Ideal for EFT protection of data lines in accordance with IEC 61000-4-4 (IEC 801-4)
- ESD-protection acc. IEC 61000-4-2  
 $\pm 30$  kV contact discharge  
 $\pm 30$  kV air discharge
- Low incremental surge resistance, excellent clamping capability
- 200 W peak pulse power capability with a 10/1000  $\mu$ s waveform, repetition rate (duty cycle): 0.01 %
- “Low-Noise” technology - very fast response time
- High temperature soldering guaranteed: 260 °C/10 s at terminals
- e3 - Sn
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### ORDERING INFORMATION

PART NUMBER (EXAMPLE)	ENVIRONMENTAL AND QUALITY CODE			TIN PLATED	PACKAGING CODE		ORDERING CODE (EXAMPLE)
	AEC-Q101 QUALIFIED	RoHS-COMPLIANT + LEAD (Pb)-FREE TERMINATIONS			3K PER 7" REEL (8 mm TAPE), 30K/BOX = MOQ	10K PER 13" REEL (8 mm TAPE), 50K/BOX = MOQ	
		STANDARD	HALOGEN-FREE				
SMF5V0A-		E		3	-08		SMF5V0A-E3-08
SMF5V0A-			M	3	-08		SMF5V0A-M3-08
SMF5V0A-	H	E		3	-08		SMF5V0A-HE3-08
SMF5V0A-	H		M	3	-08		SMF5V0A-HM3-08
SMF5V0A-		E		3		-18	SMF5V0A-E3-18
SMF5V0A-			M	3		-18	SMF5V0A-M3-18
SMF5V0A-	H	E		3		-18	SMF5V0A-HE3-18
SMF5V0A-	H		M	3		-18	SMF5V0A-HM3-18

### PACKAGE DATA

PACKAGE NAME	MOLDING COMPOUND	WEIGHT (mg)	HEIGHT MAX. (mm)	LENGTH MAX. (mm)	WIDTH MAX. (mm)	MOLDING COMPOUND	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS
SMF (DO-219AB)	Standard Halogen-free	15	1.08	3.9	1.9	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals



ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	t <sub>p</sub> = 10/1000 μs waveform	I <sub>PPM</sub>	see "Electrical Characteristics"	A
Peak pulse power	t <sub>p</sub> = 8/20 μs waveform acc. IEC 61000-4-5	P <sub>PP</sub>	1000	W
	t <sub>p</sub> = 10/1000 μs waveform		200	W
Peak forward surge current	8.3 ms single half sine-wave	I <sub>FSM</sub>	50	A
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	± 30	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		± 30	kV
Thermal resistance	Mounted on epoxy glass PCB with 3 mm x 3 mm, Cu pads (≥ 40 μm thick)	R <sub>thJA</sub>	180	K/W
Forward clamping voltage	I <sub>F</sub> = 50A, t <sub>p</sub> = 400 μs	V <sub>F</sub>	2.5	V
Operating temperature	Junction temperature	T <sub>J</sub>	- 55 to + 150	°C
Storage temperature		T <sub>STG</sub>	- 55 to + 150	°C

ELECTRICAL CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)										
PART NUMBER	TYPE CODE		REVERSE BREAKDOWN VOLTAGE at I <sub>T</sub> , t <sub>p</sub> = 5 ms	TEST CURRENT	REVERSE WORKING VOLTAGE	REVERSE CURRENT at V <sub>RWM</sub>	PEAK PULSE CURRENT at I <sub>PPM</sub> , t <sub>p</sub> = 10/1000 μs	REVERSE CLAMPING VOLTAGE at I <sub>PPM</sub>	CAPACITANCE at V <sub>R</sub> = 0 V, f = 1 MHz	PROTECTION PATHS
	STD.	HALOGEN-FREE	V <sub>BR</sub> MIN. (V)	I <sub>T</sub> (mA)	V <sub>RWM</sub> (V)	I <sub>R</sub> (μA)	I <sub>PPM</sub> (A)	V <sub>C</sub> MAX. (V)	C <sub>D</sub> TYP. (pF)	N <sub>channel</sub>
SMF5V0A	AE	NE	6.40	10	5	5	21.7	9.2	1120	1
SMF6V0A	AG	NG	6.67	10	6	26	19.4	10.3	1063	1
SMF6V5A	AK	NK	7.22	10	6.5	20	17.9	11.2	938	1
SMF7V0A	AM	NM	7.78	10	7	3	16.7	12	843	1
SMF7V5A	AP	NP	8.33	1	7.5	0.1	15.5	12.9	773	1
SMF8V0A	AR	NR	8.89	1	8	0.1	14.7	13.6	706	1
SMF8V5A	AT	NT	9.44	1	8.5	0.1	13.9	14.4	674	1
SMF9V0A	AV	NV	10	1	9	0.1	13.5	15.4	640	1
SMF10A	AX	NX	11.1	1	10	0.1	11.8	17	562	1
SMF11A	AZ	NZ	12.2	1	11	0.1	11	18.2	509	1
SMF12A	BE	OE	13.3	1	12	0.1	10.1	19.9	483	1
SMF13A	BG	OG	14.4	1	13	0.1	9.3	21.5	423	1
SMF14A	BK	OK	15.6	1	14	0.1	8.6	23.2	392	1
SMF15A	BM	OM	16.7	1	15	0.1	8.2	24.4	367	1
SMF16A	BP	OP	17.8	1	16	0.1	7.7	26	343	1
SMF17A	BR	OR	18.9	1	17	0.1	7.2	27.6	324	1
SMF18A	BT	OT	20	1	18	0.1	6.8	29.2	320	1
SMF20A	BV	OV	22.2	1	20	0.1	6.2	32.4	283	1
SMF22A	BX	OX	24.4	1	22	0.1	5.6	35.5	271	1
SMF24A	BZ	OZ	26.7	1	24	0.1	5.1	38.9	244	1
SMF26A	CE	PE	28.9	1	26	0.1	4.8	42.1	230	1
SMF28A	CG	PG	31.1	1	28	0.1	4.4	45.4	227	1
SMF30A	CK	PK	33.3	1	30	0.1	4.1	48.4	207	1
SMF33A	CM	PM	36.7	1	33	0.1	3.8	53.3	198	1
SMF36A	CP	PP	40	1	36	0.1	3.4	58.1	178	1
SMF40A	CR	PR	44.4	1	40	0.1	3.1	64.5	172	1
SMF43A	CT	PT	47.8	1	43	0.1	2.9	69.4	165	1
SMF45A	CV	PV	50	1	45	0.1	2.8	72.7	162	1
SMF48A	CX	PX	53.3	1	48	0.1	2.6	77.4	161	1
SMF51A	CZ	PZ	56.7	1	51	0.1	2.4	82.4	151	1
SMF54A	CA	PA	60	1	54	0.1	2.25	88	148	1
SMF58A	CC	PC	64.4	1	58	0.1	2.1	95	144	1

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

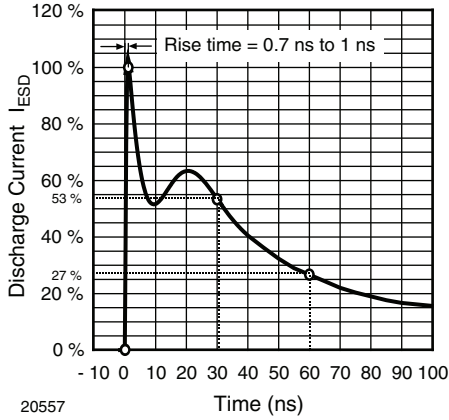


Fig. 1 - ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330 Ω/150pF)

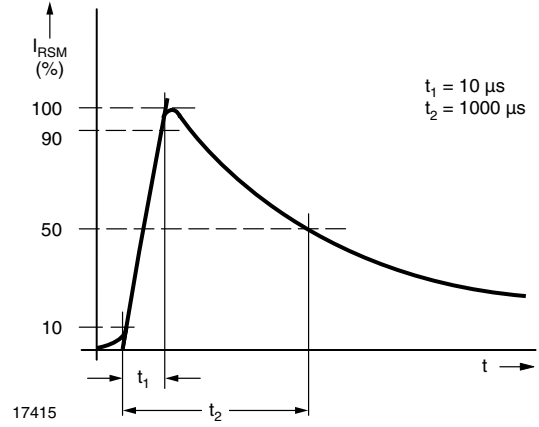


Fig. 4 - Pulse Waveform

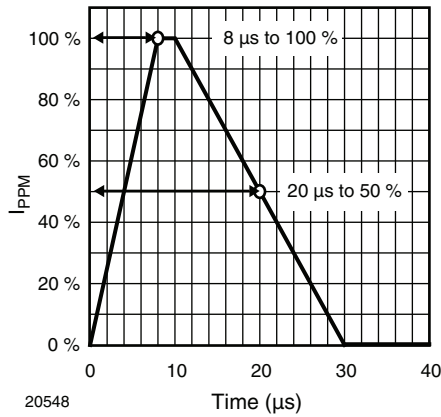


Fig. 2 - 8/20 μs Peak Pulse Current Wave Form acc. IEC 61000-4-5

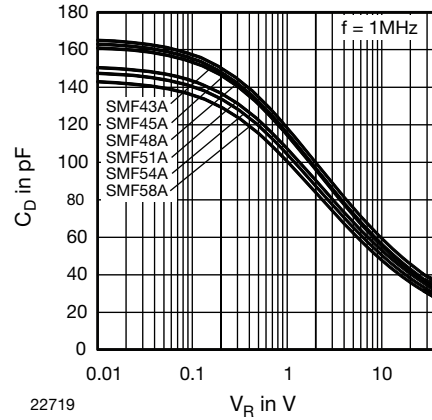


Fig. 5 - Typical Capacitance  $C_D$  vs. Reverse Voltage  $V_R$

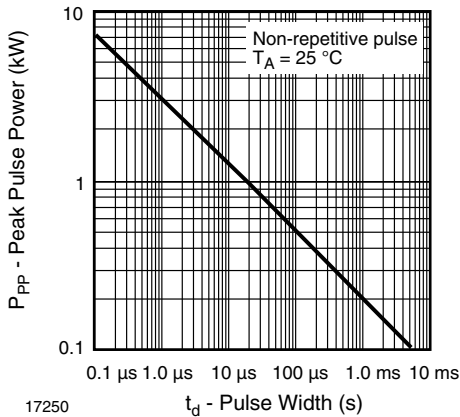


Fig. 3 - Peak Pulse Power Rating

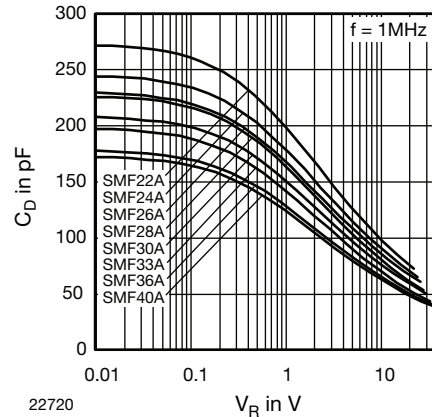


Fig. 6 - Typical Capacitance  $C_D$  vs. Reverse Voltage  $V_R$

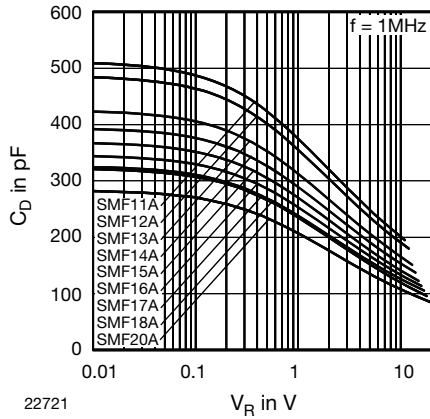


Fig. 7 - Typical Capacitance  $C_D$  vs. Reverse Voltage  $V_R$

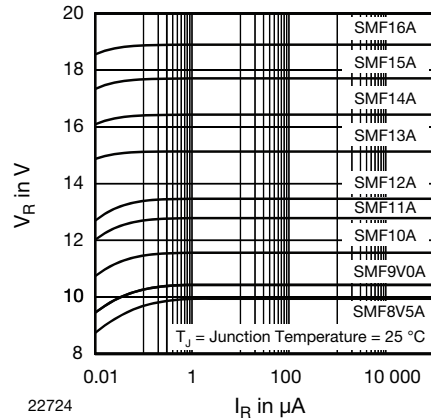


Fig. 10 - Typical Reverse Voltage  $V_R$  vs. Reverse Current  $I_R$

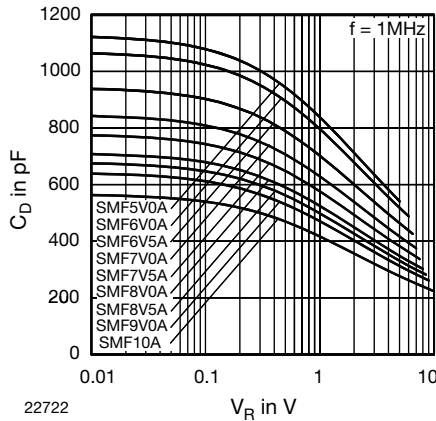


Fig. 8 - Typical Capacitance  $C_D$  vs. Reverse Voltage  $V_R$

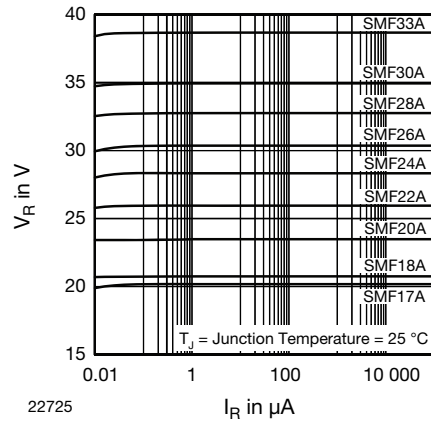


Fig. 11 - Typical Reverse Voltage  $V_R$  vs. Reverse Current  $I_R$

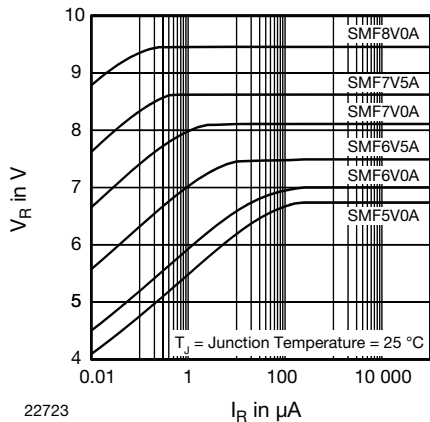


Fig. 9 - Typical Reverse Voltage  $V_R$  vs. Reverse Current  $I_R$

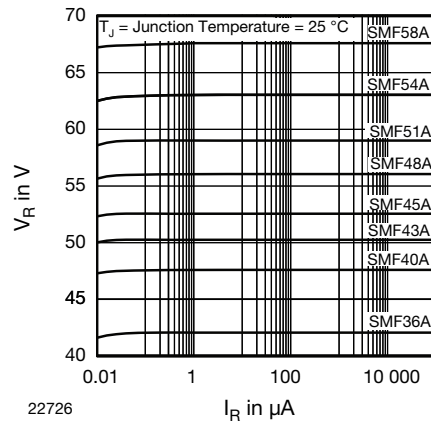
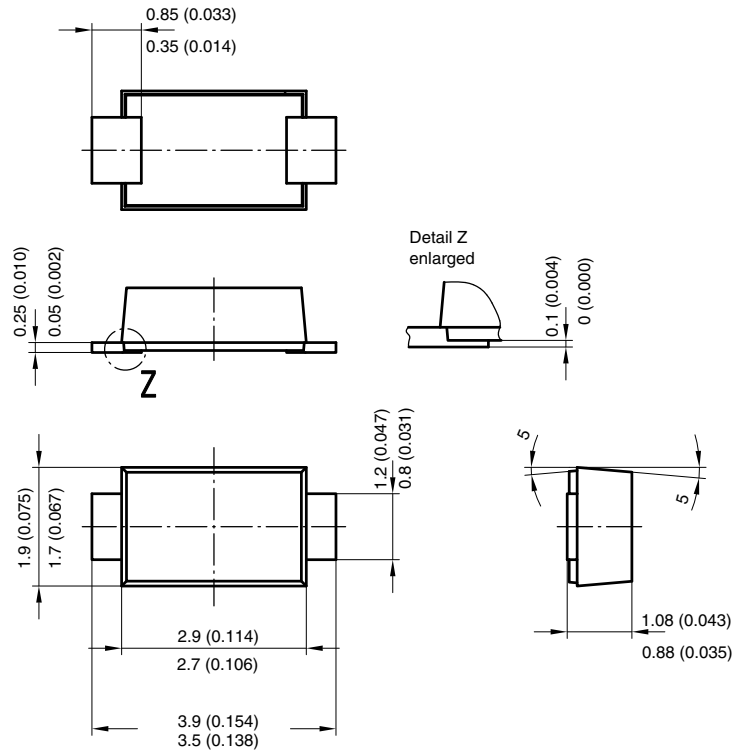


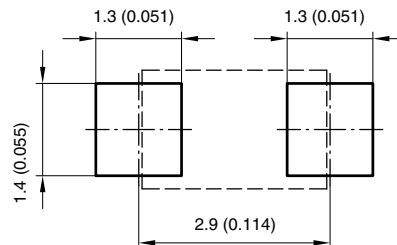
Fig. 12 - Typical Reverse Voltage  $V_R$  vs. Reverse Current  $I_R$



### PACKAGE DIMENSIONS in millimeters (inches): **SMF**

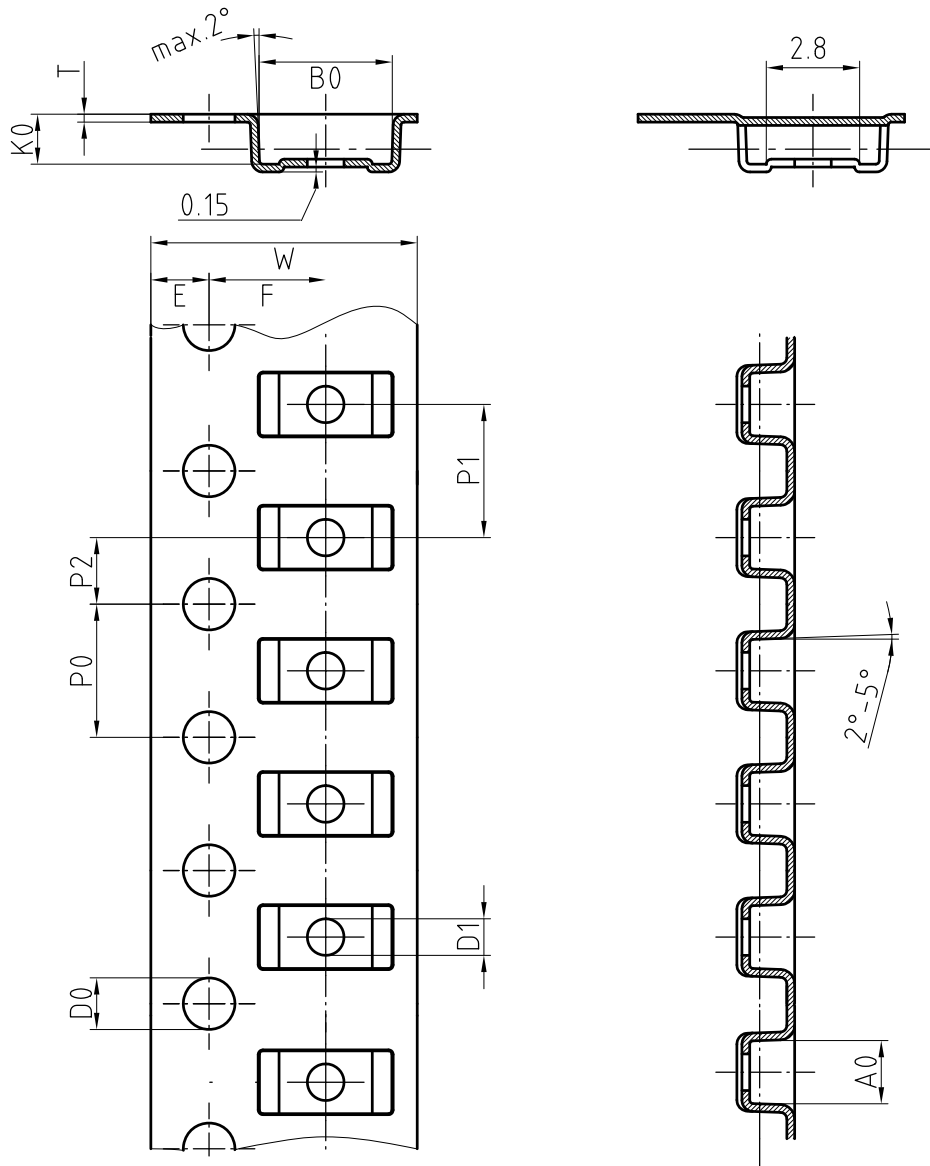


Foot print recommendation:



Created - Date: 15. February 2005  
 Rev. 3 - Date: 13. March 2007  
 Document no.:S8-V-3915.01-001 (4)  
 17247

## BLISTERTAPE DIMENSIONS in millimeters (inches)



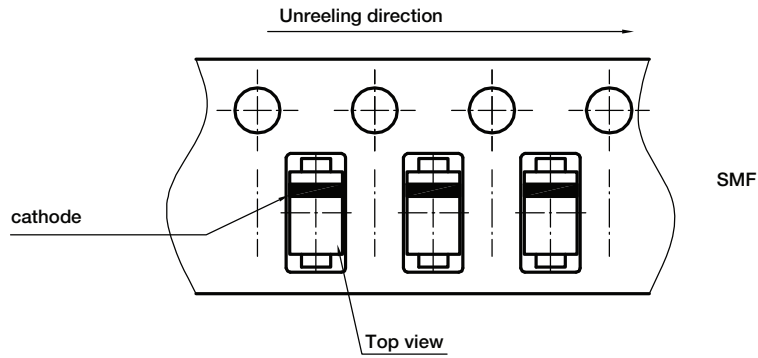
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PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

Document-No.: S8-V-3717.02-001 (3)

18513



## ORIENTATION IN CARRIER TAPE - SMF



Document no.: S8-V-3717.02-003 (4)  
Created - Date: 09. Feb. 2010  
22670



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